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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details	
Product Status	Obsolete
Number of LABs/CLBs	1536
Number of Logic Elements/Cells	6912
Total RAM Bits	131072
Number of I/O	316
Number of Gates	411955
Voltage - Supply	1.71V ~ 1.89V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	432-LBGA Exposed Pad, Metal
Supplier Device Package	432-MBGA (40x40)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xcv300e-7bg432i

For in-circuit debugging, an optional download and read-back cable is available. This cable connects the FPGA in the target system to a PC or workstation. After downloading the design into the FPGA, the designer can single-step the logic, readback the contents of the flip-flops, and so observe the internal logic state. Simple modifications can be down-loaded into the system in a matter of minutes.

Configuration

Virtex-E devices are configured by loading configuration data into the internal configuration memory. Note that attempting to load an incorrect bitstream causes configuration to fail and can damage the device.

Some of the pins used for configuration are dedicated pins, while others can be re-used as general purpose inputs and outputs once configuration is complete.

The following are dedicated pins:

- Mode pins (M2, M1, M0)
- Configuration clock pin (CCLK)
- PROGRAM pin
- DONE pin
- Boundary Scan pins (TDI, TDO, TMS, TCK)

Depending on the configuration mode chosen, CCLK can be an output generated by the FPGA, or can be generated externally and provided to the FPGA as an input. The PROGRAM pin must be pulled High prior to reconfiguration.

Note that some configuration pins can act as outputs. For correct operation, these pins require a V_{CCO} of 3.3 V or 2.5 V. At 3.3 V the pins operate as LVTTL, and at 2.5 V they operate as LVCMOS. All affected pins fall in banks 2 or 3. The configuration pins needed for SelectMap (CS, Write) are located in bank 1.

Configuration Modes

Virtex-E supports the following four configuration modes.

- Slave-serial mode
- Master-serial mode
- SelectMAP mode
- Boundary Scan mode (JTAG)

The Configuration mode pins (M2, M1, M0) select among these configuration modes with the option in each case of having the IOB pins either pulled up or left floating prior to configuration. The selection codes are listed in Table 8.

Configuration through the Boundary Scan port is always available, independent of the mode selection. Selecting the Boundary Scan mode simply turns off the other modes. The three mode pins have internal pull-up resistors, and default to a logic High if left unconnected. However, it is recommended to drive the configuration mode pins externally.

Table 8: **Configuration Codes**

Configuration Mode	M2(1)	M1	M0	CCLK Direction	Data Width	Serial D_{out}	Configuration Pull-ups(1)
Master-serial mode	0	0	0	Out	1	Yes	No
Boundary Scan mode	1	0	1	N/A	1	No	No
SelectMAP mode	1	1	0	In	8	No	No
Slave-serial mode	1	1	1	In	1	Yes	No
Master-serial mode	1	0	0	Out	1	Yes	Yes
Boundary Scan mode	0	0	1	N/A	1	No	Yes
SelectMAP mode	0	1	0	In	8	No	Yes
Slave-serial mode	0	1	1	In	1	Yes	Yes

Notes:
1. M2 is sampled continuously from power up until the end of the configuration. Toggling M2 while INIT is being held externally Low can cause the configuration pull-up settings to change.

DLL Properties

Properties provide access to some of the Virtex-E series DLL features, (for example, clock division and duty cycle correction).

Duty Cycle Correction Property

The 1x clock outputs, CLK0, CLK90, CLK180, and CLK270, use the duty-cycle corrected default, exhibiting a 50/50 duty cycle. The DUTY_CYCLE_CORRECTION property (by default TRUE) controls this feature. To deactivate the DLL duty-cycle correction for the 1x clock outputs, attach the DUTY_CYCLE_CORRECTION=FALSE property to the DLL symbol.

Clock Divide Property

The CLKDV_DIVIDE property specifies how the signal on the CLKDV pin is frequency divided with respect to the CLK0 pin. The values allowed for this property are 1.5, 2, 2.5, 3, 4, 5, 8, or 16; the default value is 2.

Startup Delay Property

This property, STARTUP_WAIT, takes on a value of TRUE or FALSE (the default value). When TRUE the device configuration DONE signal waits until the DLL locks before going to High.

Virtex-E DLL Location Constraints

As shown in Figure 26, there are four additional DLLs in the Virtex-E devices, for a total of eight per Virtex-E device. These DLLs are located in silicon, at the top and bottom of the two innermost block SelectRAM columns. The location constraint LOC, attached to the DLL symbol with the identifier DLL0S, DLL0P, DLL1S, DLL1P, DLL2S, DLL2P, DLL3S, or DLL3P, controls the DLL location.

The LOC property uses the following form:

LOC = DLL0P

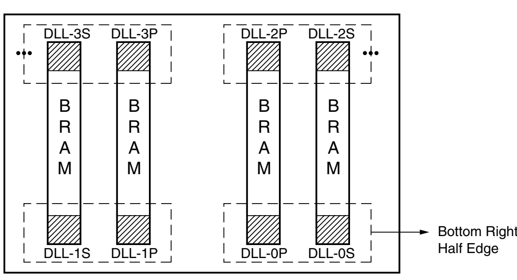

Figure 26: **Virtex Series DLLs**

Design Factors

Use the following design considerations to avoid pitfalls and improve success designing with Xilinx devices.

Input Clock

The output clock signal of a DLL, essentially a delayed version of the input clock signal, reflects any instability on the input clock in the output waveform. For this reason the quality of the DLL input clock relates directly to the quality of the output clock waveforms generated by the DLL. The DLL input clock requirements are specified in the data sheet.

In most systems a crystal oscillator generates the system clock. The DLL can be used with any commercially available quartz crystal oscillator. For example, most crystal oscillators produce an output waveform with a frequency tolerance of 100 PPM, meaning 0.01 percent change in the clock period. The DLL operates reliably on an input waveform with a frequency drift of up to 1 ns — orders of magnitude in excess of that needed to support any crystal oscillator in the industry. However, the cycle-to-cycle jitter must be kept to less than 300 ps in the low frequencies and 150 ps for the high frequencies.

Input Clock Changes

Changing the period of the input clock beyond the maximum drift amount requires a manual reset of the CLKDLL. Failure to reset the DLL produces an unreliable lock signal and output clock.

It is possible to stop the input clock with little impact to the DLL. Stopping the clock should be limited to less than 100 µs to keep device cooling to a minimum. The clock should be stopped during a Low phase, and when restored the full High period should be seen. During this time, LOCKED stays High and remains High when the clock is restored.

When the clock is stopped, one to four more clocks are still observed as the delay line is flushed. When the clock is restarted, the output clocks are not observed for one to four clocks as the delay line is filled. The most common case is two or three clocks.

In a similar manner, a phase shift of the input clock is also possible. The phase shift propagates to the output one to four clocks after the original shift, with no disruption to the CLKDLL control.

Output Clocks

As mentioned earlier in the DLL pin descriptions, some restrictions apply regarding the connectivity of the output pins. The DLL clock outputs can drive an OBUF, a global clock buffer BUFG, or they can route directly to destination clock pins. The only BUFGs that the DLL clock outputs can drive are the two on the same edge of the device (top or bottom). In addition, the CLK2X output of the secondary DLL can connect directly to the CLKIN of the primary DLL in the same quadrant.

Do not use the DLL output clock signals until after activation of the LOCKED signal. Prior to the activation of the LOCKED signal, the DLL output clocks are not valid and can exhibit glitches, spikes, or other spurious movement.

SSTL3_I

A sample circuit illustrating a valid termination technique for SSTL3_I appears in Figure 49. DC voltage specifications appear in Table 28.

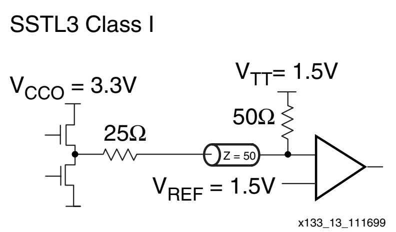

Figure 49: **Terminated SSTL3 Class I**

Table 28: **SSTL3_I Voltage Specifications**

Parameter	Min	Typ	Max
V_{CCO}	**3.0**	**3.3**	**3.6**
$V_{REF} = 0.45 \times V_{CCO}$	1.3	1.5	1.7
$V_{TT} = V_{REF}$	1.3	1.5	1.7
$V_{IH} = V_{REF} + 0.2$	1.5	1.7	3.9(1)
$V_{IL} = V_{REF} - 0.2$	–0.3(2)	1.3	1.5
$V_{OH} = V_{REF} + 0.6$	1.9	-	-
$V_{OL} = V_{REF} - 0.6$	-	-	1.1
I_{OH} at V_{OH} (mA)	–8	-	-
I_{OL} at V_{OL} (mA)	8	-	-

Notes:
1. V_{IH} maximum is $V_{CCO} + 0.3$
2. V_{IL} minimum does not conform to the formula

SSTL3_II

A sample circuit illustrating a valid termination technique for SSTL3_II appears in Figure 50. DC voltage specifications appear in Table 29.

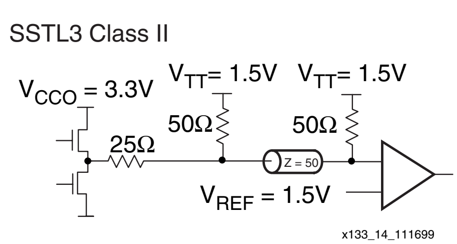

Figure 50: **Terminated SSTL3 Class II**

Table 29: **SSTL3_II Voltage Specifications**

Parameter	Min	Typ	Max
V_{CCO}	3.0	3.3	3.6
$V_{REF} = 0.45 \times V_{CCO}$	1.3	1.5	1.7
$V_{TT} = V_{REF}$	1.3	1.5	1.7
$V_{IH} = V_{REF} + 0.2$	1.5	1.7	3.9(1)
$V_{IL} = V_{REF} - 0.2$	–0.3(2)	1.3	1.5
$V_{OH} = V_{REF} + 0.8$	2.1	-	-
$V_{OL} = V_{REF} - 0.8$	-	-	0.9
I_{OH} at V_{OH} (mA)	–16	-	-
I_{OL} at V_{OL} (mA)	16	-	-

Notes:
1. V_{IH} maximum is $V_{CCO} + 0.3$
2. V_{IL} minimum does not conform to the formula

SSTL2_I

A sample circuit illustrating a valid termination technique for SSTL2_I appears in Figure 51. DC voltage specifications appear in Table 30.

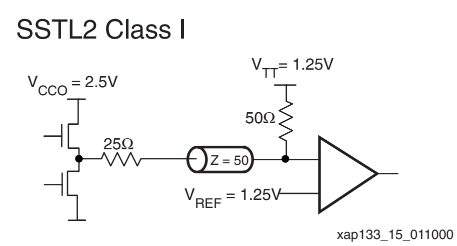

Figure 51: **Terminated SSTL2 Class I**

Table 30: **SSTL2_I Voltage Specifications**

Parameter	Min	Typ	Max
V_{CCO}	2.3	2.5	2.7
$V_{REF} = 0.5 \times V_{CCO}$	1.15	1.25	1.35
$V_{TT} = V_{REF} + N$(1)	1.11	1.25	1.39
$V_{IH} = V_{REF} + 0.18$	1.33	1.43	3.0(2)
$V_{IL} = V_{REF} - 0.18$	–0.3(3)	1.07	1.17
$V_{OH} = V_{REF} + 0.61$	1.76	-	-
$V_{OL} = V_{REF} - 0.61$	-	-	0.74
I_{OH} at V_{OH} (mA)	–7.6	-	-
I_{OL} at V_{OL} (mA)	7.6	-	-

Notes:
1. N must be greater than or equal to -0.04 and less than or equal to 0.04.
2. V_{IH} maximum is $V_{CCO} + 0.3$.
3. V_{IL} minimum does not conform to the formula.

LVDS

Depending on whether the device is transmitting an LVDS signal or receiving an LVDS signal, there are two different circuits used for LVDS termination. A sample circuit illustrating a valid termination technique for transmitting LVDS signals appears in Figure 54. A sample circuit illustrating a valid termination for receiving LVDS signals appears in Figure 55. Table 38 lists DC voltage specifications. Further information on the specific termination resistor packs shown can be found on Table 40.

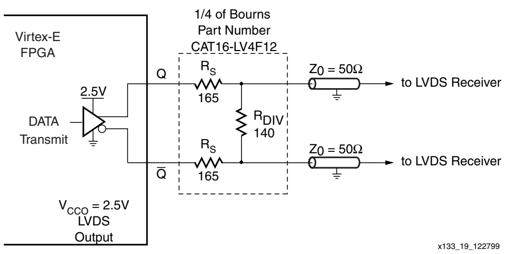

Figure 54: **Transmitting LVDS Signal Circuit**

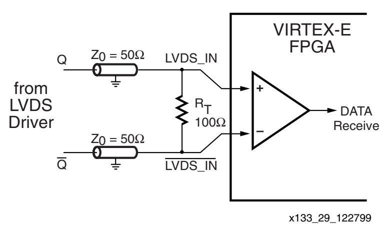

Figure 55: **Receiving LVDS Signal Circuit**

Table 38: **LVDS Voltage Specifications**

Parameter	Min	Typ	Max
V_{CCO}	2.375	2.5	2.625
V_{ICM}(2)	0.2	1.25	2.2
V_{OCM}(1)	1.125	1.25	1.375
V_{IDIFF} (1)	0.1	0.35	-
V_{ODIFF} (1)	0.25	0.35	0.45
V_{OH}(1)	1.25	-	-
V_{OL}(1)	-	-	1.25

Notes:

1. Measured with a 100 Ω resistor across Q and $\overline{Q}$.
2. Measured with a differential input voltage = +/– 350 mV.

LVPECL

Depending on whether the device is transmitting or receiving an LVPECL signal, two different circuits are used for LVPECL termination. A sample circuit illustrating a valid termination technique for transmitting LVPECL signals appears in Figure 56. A sample circuit illustrating a valid termination for receiving LVPECL signals appears in Figure 57. Table 39 lists DC voltage specifications. Further information on the specific termination resistor packs shown can be found on Table 40.

Table 39: **LVPECL Voltage Specifications**

Parameter	Min	Typ	Max
V_{CCO}	3.0	3.3	3.6
V_{REF}	-	-	-
V_{TT}	-	-	-
V_{IH}	1.49	-	2.72
V_{IL}	0.86	-	2.125
V_{OH}	1.8	-	-
V_{OL}	-	-	1.57

Notes:

1. For more detailed information, see DS022-3: *Virtex-E 1.8V FPGA DC and Switching Characteristics*, Module 3, LVPECL DC Specifications section.

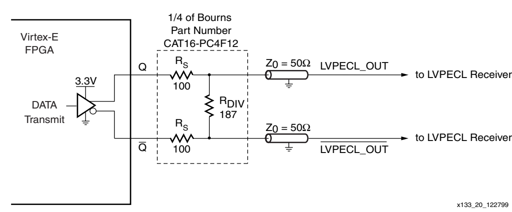

Figure 56: **Transmitting LVPECL Signal Circuit**

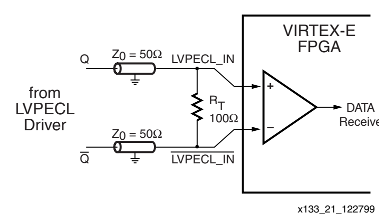

Figure 57: **Receiving LVPECL Signal Circuit**

Virtex-E Switching Characteristics

All devices are 100% functionally tested. Internal timing parameters are derived from measuring internal test patterns. Listed below are representative values. For more specific, more precise, and worst-case guaranteed data, use the values reported by the static timing analyzer (TRCE in the Xilinx Development System) and back-annotated to the simulation net list. All timing parameters assume worst-case operating conditions (supply voltage and junction temperature). Values apply to all Virtex-E devices unless otherwise noted.

IOB Input Switching Characteristics

Input delays associated with the pad are specified for LVTTL levels in Table 2. For other standards, adjust the delays with the values shown in **IOB Input Switching Characteristics Standard Adjustments**, page 8.

Table 2: **IOB Input Switching Characteristics**

			Speed Grade(1)				
Description(2)	**Symbol**	**Device**	**Min**	**-8**	**-7**	**-6**	**Units**
Propagation Delays							
Pad to I output, no delay	T_{IOPI}	All	0.43	0.8	0.8	0.8	ns, max
Pad to I output, with delay	T_{IOPID}	XCV50E	0.51	1.0	1.0	1.0	ns, max
		XCV100E	0.51	1.0	1.0	1.0	ns, max
		XCV200E	0.51	1.0	1.0	1.0	ns, max
		XCV300E	0.51	1.0	1.0	1.0	ns, max
		XCV400E	0.51	1.0	1.0	1.0	ns, max
		XCV600E	0.51	1.0	1.0	1.0	ns, max
		XCV1000E	0.55	1.1	1.1	1.1	ns, max
		XCV1600E	0.55	1.1	1.1	1.1	ns, max
		XCV2000E	0.55	1.1	1.1	1.1	ns, max
		XCV2600E	0.55	1.1	1.1	1.1	ns, max
		XCV3200E	0.55	1.1	1.1	1.1	ns, max
Pad to output IQ via transparent latch, no delay	T_{IOPLI}	All	0.8	1.4	1.5	1.6	ns, max
Pad to output IQ via transparent latch, with delay	T_{IOPLID}	XCV50E	1.31	2.9	3.0	3.1	ns, max
		XCV100E	1.31	2.9	3.0	3.1	ns, max
		XCV200E	1.39	3.1	3.2	3.3	ns, max
		XCV300E	1.39	3.1	3.2	3.3	ns, max
		XCV400E	1.43	3.2	3.3	3.4	ns, max
		XCV600E	1.55	3.5	3.6	3.7	ns, max
		XCV1000E	1.55	3.5	3.6	3.7	ns, max
		XCV1600E	1.59	3.6	3.7	3.8	ns, max
		XCV2000E	1.59	3.6	3.7	3.8	ns, max
		XCV2600E	1.59	3.6	3.7	3.8	ns, max
		XCV3200E	1.59	3.6	3.7	3.8	ns, max

Virtex-E Pin-to-Pin Output Parameter Guidelines

All devices are 100% functionally tested. Listed below are representative values for typical pin locations and normal clock loading. Values are expressed in nanoseconds unless otherwise noted.

Global Clock Input to Output Delay for LVTTL, 12 mA, Fast Slew Rate, *with* DLL

Description[1]	Symbol	Device	Speed Grade[2, 3]				Units
			Min	-8	-7	-6	
LVTTL Global Clock Input to Output Delay using Output Flip-flop, 12 mA, Fast Slew Rate, *with* DLL. For data *output* with different standards, adjust the delays with the values shown in **IOB Output Switching Characteristics Standard Adjustments**, page 10.	$T_{ICKOFDLL}$	XCV50E	1.0	3.1	3.1	3.1	ns
		XCV100E	1.0	3.1	3.1	3.1	ns
		XCV200E	1.0	3.1	3.1	3.1	ns
		XCV300E	1.0	3.1	3.1	3.1	ns
		XCV400E	1.0	3.1	3.1	3.1	ns
		XCV600E	1.0	3.1	3.1	3.1	ns
		XCV1000E	1.0	3.1	3.1	3.1	ns
		XCV1600E	1.0	3.1	3.1	3.1	ns
		XCV2000E	1.0	3.1	3.1	3.1	ns
		XCV2600E	1.0	3.1	3.1	3.1	ns
		XCV3200E	1.0	3.1	3.1	3.1	ns

Notes:
1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. Output timing is measured at 50% V_{CC} threshold with 35 pF external capacitive load. For other I/O standards and different loads, see Table 3 and Table 4.
3. DLL output jitter is already included in the timing calculation.

Table 12: **BG432 — XCV300E, XCV400E, XCV600E**

Bank	Pin Description	Pin #
7	IO_L132P_Y	G28
7	IO_L133N	E31
7	IO_L133P	E30
7	IO_L134N_Y	F29
7	IO_VREF_L134P_Y	F28
7	IO_L135N_Y	D31
7	IO_L135P_Y	D30
7	IO_L136N	E29
7	IO_L136P	E28
2	CCLK	D4
3	DONE	AH4
NA	DXN	AH27
NA	DXP	AK29
NA	M0	AH28
NA	M1	AH29
NA	M2	AJ28
NA	PROGRAM	AH3
NA	TCK	D28
NA	TDI	B3
2	TDO	C4
NA	TMS	D29
NA	VCCINT	A10
NA	VCCINT	A17
NA	VCCINT	B23
NA	VCCINT	B26
NA	VCCINT	C7
NA	VCCINT	C14
NA	VCCINT	C19
NA	VCCINT	F1
NA	VCCINT	F30
NA	VCCINT	K3
NA	VCCINT	K29
NA	VCCINT	N2
NA	VCCINT	N29

Table 12: **BG432 — XCV300E, XCV400E, XCV600E**

Bank	Pin Description	Pin #
NA	VCCINT	T1
NA	VCCINT	T29
NA	VCCINT	W2
NA	VCCINT	W31
NA	VCCINT	AB2
NA	VCCINT	AB30
NA	VCCINT	AE29
NA	VCCINT	AF1
NA	VCCINT	AH8
NA	VCCINT	AH24
NA	VCCINT	AJ10
NA	VCCINT	AJ16
NA	VCCINT	AK22
NA	VCCINT	AK13
NA	VCCINT	AK19
0	VCCO	A21
0	VCCO	C29
0	VCCO	D21
1	VCCO	A1
1	VCCO	A11
1	VCCO	D11
2	VCCO	C3
2	VCCO	L4
2	VCCO	L1
3	VCCO	AA1
3	VCCO	AA4
3	VCCO	AJ3
4	VCCO	AH11
4	VCCO	AL1
4	VCCO	AL11
5	VCCO	AH21
5	VCCO	AL21
5	VCCO	AJ29
6	VCCO	AA28
6	VCCO	AA31

Table 14: **BG560 — XCV400E, XCV600E, XCV1000E, XCV1600E, XCV2000E**

Bank	Pin Description	Pin#	See Note
3	IO_D4_L73P_YY	W4	
3	IO_VREF_L73N_YY	W5	
3	IO_L74P_Y	Y3	
3	IO_L74N_Y	Y4	
3	IO_L75P_Y	AA1	
3	IO_L75N_Y	Y5	
3	IO_L76P_Y	AA3	
3	IO_VREF_L76N_Y	AA4	3
3	IO_L77P_Y	AB3	
3	IO_L77N_Y	AA5	
3	IO_L78P_Y	AC1	
3	IO_L78N_Y	AB4	
3	IO_L79P_YY	AC3	
3	IO_D5_L79N_YY	AB5	
3	IO_D6_L80P_YY	AC4	
3	IO_VREF_L80N_YY	AD3	
3	IO_L81P_Y	AE1	
3	IO_L81N_Y	AC5	
3	IO_L82P_Y	AD4	
3	IO_VREF_L82N_Y	AF1	4
3	IO_L83P_Y	AF2	
3	IO_L83N_Y	AD5	
3	IO_L84P_Y	AG2	
3	IO_VREF_L84N_Y	AE4	1
3	IO_L85P_YY	AH1	
3	IO_VREF_L85N_YY	AE5	
3	IO_L86P_Y	AF4	
3	IO_L86N_Y	AJ1	
3	IO_L87P_Y	AJ2	
3	IO_L87N_Y	AF5	
3	IO_L88P_Y	AG4	
3	IO_VREF_L88N_Y	AK2	
3	IO_L89P_Y	AJ3	
3	IO_L89N_Y	AG5	
3	IO_L90P_Y	AL1	

Table 14: **BG560 — XCV400E, XCV600E, XCV1000E, XCV1600E, XCV2000E**

Bank	Pin Description	Pin#	See Note
3	IO_VREF_L90N_Y	AH4	3
3	IO_D7_L91P_YY	AJ4	
3	IO_INIT_L91N_YY	AH5	
3	IO	U4	
4	GCK0	AL17	
4	IO	AJ8	
4	IO	AJ11	
4	IO	AK6	
4	IO	AK9	
4	IO_L92P_YY	AL4	
4	IO_L92N_YY	AJ6	
4	IO_L93P_Y	AK5	
4	IO_VREF_L93N_Y	AN3	3
4	IO_L94P_YY	AL5	
4	IO_L94N_YY	AJ7	
4	IO_VREF_L95P_YY	AM4	
4	IO_L95N_YY	AM5	
4	IO_L96P_Y	AK7	
4	IO_L96N_Y	AL6	
4	IO_L97P_YY	AM6	
4	IO_L97N_YY	AN6	
4	IO_VREF_L98P_YY	AL7	
4	IO_L98N_YY	AJ9	
4	IO_L99P_Y	AN7	
4	IO_VREF_L99N_Y	AL8	1
4	IO_L100P_Y	AM8	
4	IO_L100N_Y	AJ10	
4	IO_VREF_L101P_Y	AL9	4
4	IO_L101N_Y	AM9	
4	IO_L102P_Y	AK10	
4	IO_L102N_Y	AN9	
4	IO_VREF_L103P_YY	AL10	
4	IO_L103N_YY	AM10	
4	IO_L104P_YY	AL11	

Table 15: **BG560 Differential Pin Pair Summary XCV400E, XCV600E, XCV1000E, XCV1600E, XCV2000E**

Pair	Bank	P Pin	N Pin	AO	Other Functions
47	2	F4	C1	14	-
48	2	G5	E3	15	VREF
49	2	D2	G4	16	-
50	2	H5	E2	15	-
51	2	H4	G3	√	VREF
52	2	J5	F1	17	VREF
53	2	J4	H3	14	-
54	2	K5	H2	18	VREF
55	2	J3	K4	19	-
56	2	L5	K3	√	D1
57	2	L4	K2	√	D2
58	2	M5	L3	17	-
59	2	L1	M4	14	-
60	2	N5	M2	15	VREF
61	2	N4	N3	16	-
62	2	N2	P5	15	-
63	2	P4	P3	√	D3
64	2	P2	R5	17	-
65	2	R4	R3	14	-
66	2	R1	T4	18	VREF
67	2	T5	T3	19	VREF
68	2	T2	U3	√	-
69	3	U1	U2	19	VREF
70	3	V2	V4	18	VREF
71	3	V5	V3	14	-
72	3	W1	W3	17	-
73	3	W4	W5	√	VREF
74	3	Y3	Y4	15	-
75	3	AA1	Y5	16	-
76	3	AA3	AA4	15	VREF
77	3	AB3	AA5	14	-

Table 15: **BG560 Differential Pin Pair Summary XCV400E, XCV600E, XCV1000E, XCV1600E, XCV2000E**

Pair	Bank	P Pin	N Pin	AO	Other Functions
78	3	AC1	AB4	17	-
79	3	AC3	AB5	√	D5
80	3	AC4	AD3	√	VREF
81	3	AE1	AC5	4	-
82	3	AD4	AF1	18	VREF
83	3	AF2	AD5	14	-
84	3	AG2	AE4	20	VREF
85	3	AH1	AE5	√	VREF
86	3	AF4	AJ1	15	-
87	3	AJ2	AF5	14	-
88	3	AG4	AK2	15	VREF
89	3	AJ3	AG5	14	-
90	3	AL1	AH4	14	VREF
91	3	AJ4	AH5	√	INIT
92	4	AL4	AJ6	√	-
93	4	AK5	AN3	8	VREF
94	4	AL5	AJ7	√	-
95	4	AM4	AM5	√	VREF
96	4	AK7	AL6	3	-
97	4	AM6	AN6	√	-
98	4	AL7	AJ9	√	VREF
99	4	AN7	AL8	9	VREF
100	4	AM8	AJ10	7	-
101	4	AL9	AM9	7	VREF
102	4	AK10	AN9	2	-
103	4	AL10	AM10	√	VREF
104	4	AL11	AJ12	√	-
105	4	AN11	AK12	8	-
106	4	AL12	AM12	√	-
107	4	AK13	AL13	√	VREF
108	4	AM13	AN13	3	-

Table 15: **BG560 Differential Pin Pair Summary XCV400E, XCV600E, XCV1000E, XCV1600E, XCV2000E**

Pair	Bank	P Pin	N Pin	AO	Other Functions
109	4	AJ14	AK14	√	-
110	4	AM14	AN15	√	VREF
111	4	AJ15	AK15	1	-
112	4	AL15	AM16	7	-
113	4	AL16	AJ16	7	VREF
114	4	AK16	AN17	2	VREF
115	5	AM17	AM18	NA	IO_LVDS_DLL
116	5	AK18	AJ18	7	VREF
117	5	AN19	AL19	7	-
118	5	AK19	AM20	9	-
119	5	AJ19	AL20	√	VREF
120	5	AN21	AL21	√	-
121	5	AJ20	AM22	3	-
122	5	AK21	AN23	√	VREF
123	5	AJ21	AM23	√	-
124	5	AK22	AM24	8	-
125	5	AL23	AJ22	√	-
126	5	AK23	AL24	√	VREF
127	5	AN26	AJ23	13	-
128	5	AK24	AM26	7	VREF
129	5	AM27	AJ24	7	-
130	5	AL26	AK25	5	VREF
131	5	AN29	AJ25	√	VREF
132	5	AK26	AM29	√	-
133	5	AM30	AJ26	11	-
134	5	AK27	AL29	√	VREF
135	5	AN31	AJ27	√	-
136	5	AM31	AK28	12	VREF
137	6	AJ30	AH29	√	-
138	6	AH30	AK31	17	VREF
139	6	AJ31	AG29	14	-
140	6	AG30	AK32	15	VREF
141	6	AF29	AH31	16	-
142	6	AF30	AH32	15	-
143	6	AH33	AE29	√	VREF
144	6	AE30	AG33	17	VREF
145	6	AF32	AD29	14	-
146	6	AD30	AE31	18	VREF
147	6	AC29	AE32	19	-
148	6	AC30	AD31	√	VREF
149	6	AC31	AB29	√	-
150	6	AB30	AC33	17	-
151	6	AA29	AB31	14	-
152	6	AA31	AA30	15	VREF
153	6	Y29	AA32	16	-
154	6	Y30	AA33	15	-
155	6	W29	Y32	√	VREF
156	6	W31	W30	17	-
157	6	V30	W33	14	-
158	6	V31	V29	18	VREF
159	6	U33	V32	19	VREF
160	7	U32	U31	√	-
161	7	T30	T32	19	VREF
162	7	T31	T29	18	VREF
163	7	R31	R33	14	-
164	7	R29	R30	17	-
165	7	P31	P32	√	VREF
166	7	P29	P30	15	-
167	7	N31	M32	16	-
168	7	L33	N30	15	VREF
169	7	L32	M31	14	-
170	7	L31	M30	17	-

Table 18: **FG456 — XCV200E and XCV300E**

Bank	Pin Description	Pin #
NA	VCCINT	T15
NA	VCCINT	T16
NA	VCCINT	U6
NA	VCCINT	U17
NA	VCCINT	V5
NA	VCCINT	V18
NA	VCCO_7	L7
NA	VCCO_7	K7
NA	VCCO_7	K6
NA	VCCO_7	J6
NA	VCCO_7	H6
NA	VCCO_7	G6
NA	VCCO_6	N7
NA	VCCO_6	M7
NA	VCCO_6	T6
NA	VCCO_6	R6
NA	VCCO_6	P6
NA	VCCO_6	N6
NA	VCCO_5	U10
NA	VCCO_5	U9
NA	VCCO_5	U8
NA	VCCO_5	U7
NA	VCCO_5	T11
NA	VCCO_5	T10
NA	VCCO_4	U16
NA	VCCO_4	U15
NA	VCCO_4	U14
NA	VCCO_4	U13
NA	VCCO_4	T13
NA	VCCO_4	T12
NA	VCCO_3	T17
NA	VCCO_3	R17
NA	VCCO_3	P17
NA	VCCO_3	N17
NA	VCCO_3	N16
NA	VCCO_3	M16

Table 18: **FG456 — XCV200E and XCV300E**

Bank	Pin Description	Pin #
NA	VCCO_2	K17
NA	VCCO_2	J17
NA	VCCO_2	H17
NA	VCCO_2	G17
NA	VCCO_2	L16
NA	VCCO_2	K16
NA	VCCO_1	G13
NA	VCCO_1	G12
NA	VCCO_1	F16
NA	VCCO_1	F15
NA	VCCO_1	F14
NA	VCCO_1	F13
NA	VCCO_0	G11
NA	VCCO_0	G10
NA	VCCO_0	F10
NA	VCCO_0	F9
NA	VCCO_0	F8
NA	VCCO_0	F7
NA	GND	AB22
NA	GND	AB1
NA	GND	AA21
NA	GND	AA2
NA	GND	Y20
NA	GND	Y3
NA	GND	P14
NA	GND	P13
NA	GND	P12
NA	GND	P11
NA	GND	P10
NA	GND	P9
NA	GND	N14
NA	GND	N13
NA	GND	N12
NA	GND	N11
NA	GND	N10
NA	GND	N9

Table 19: **FG456 Differential Pin Pair Summary XCV200E, XCV300E**

Pair	Bank	P Pin	N Pin	AO	Other Functions
18	1	C14	B14	2	-
19	1	A15	F12	2	-
20	1	C15	B15	√	-
21	1	E14	A16	√	VREF
22	1	C16	D14	2	-
23	1	A17	D15	2	-
24	1	A18	B17	√	VREF
25	1	C17	D16	√	-
26	1	A19	B18	√	VREF
27	1	C18	D17	√	-
28	1	C19	A20	√	CS
29	2	C21	D20	√	DIN, D0
30	2	C22	D21	√	-
31	2	D22	E21	√	VREF
32	2	E22	F18	√	-
33	2	F21	F19	√	VREF
34	2	F22	G19	2	-
35	2	G20	G18	1	-
36	2	H18	H22	2	D1, VREF
37	2	H20	H19	√	D2
38	2	H21	J19	√	-
39	2	J18	J20	√	-
40	2	K18	J21	2	-
41	2	K22	K21	1	VREF
42	2	K19	L22	2	-
43	2	L21	L18	√	-
44	2	L17	L20	√	-
45	3	M18	M20	√	-
46	3	M19	M17	2	-
47	3	N22	N21	2	VREF
48	3	N20	N18	√	-
49	3	N19	P21	√	-
50	3	P20	P19	√	-
51	3	P18	R21	√	D5
52	3	T22	R19	2	VREF
53	3	U22	R18	2	-
54	3	T21	V22	√	-
55	3	T20	U21	√	VREF
56	3	W22	T18	√	-
57	3	U19	U20	√	VREF
58	3	W21	AA22	√	-
59	3	Y21	V19	√	INIT
60	4	W18	AA20	√	-
61	4	Y18	V17	NA	-
62	4	AB20	W17	√	VREF
63	4	AA18	V16	NA	-
64	4	AB19	AB18	√	VREF
65	4	W16	AA17	1	-
66	4	Y16	V15	1	-
67	4	AB16	Y15	√	VREF
68	4	AA15	AB15	√	-
69	4	W15	Y14	1	-
70	4	V14	AA14	1	-
71	4	AB14	V13	NA	-
72	4	AA13	AB13	√	VREF
73	4	W13	AA12	2	-
74	4	Y12	V12	2	-
75	5	U12	AA11	NA	IO_LVDS_DLL
76	5	AB11	W11	1	-
77	5	V11	Y10	√	VREF
78	5	AB10	W10	√	-
79	5	V10	Y9	2	-
80	5	AB9	W9	2	-
81	5	V9	AA8	√	-
82	5	Y8	W8	√	VREF
83	5	W7	AA7	2	-
84	5	AB6	AA6	2	-
85	5	AB5	AA5	√	VREF
86	5	Y7	W6	√	-
87	5	AA4	Y6	√	VREF

Table 23: **FG680 Differential Pin Pair Summary XCV600E, XCV1000E, XCV1600E, XCV2000E**

Pair	Bank	P Pin	N Pin	AO	Other Functions
52	1	B8	A8	√	VREF
53	1	A7	D9	√	-
54	1	B7	C8	3	-
55	1	A6	D8	3	-
56	1	B6	C7	√	VREF
57	1	A5	D7	√	-
58	1	B5	C6	5	VREF
59	1	A4	D6	5	-
60	1	D5	B4	√	CS
61	2	E3	C2	√	DIN, D0
62	2	D3	F3	6	-
63	2	D2	G4	4	VREF
64	2	G3	E2	4	-
65	2	H4	E1	6	VREF
66	2	H3	F2	√	-
67	2	J4	F1	4	-
68	2	J3	G2	6	-
69	2	G1	K4	√	VREF
70	2	H2	K3	√	-
71	2	H1	L4	7	VREF
72	2	J2	L3	4	-
73	2	J1	M3	√	VREF
74	2	K2	N4	√	-
75	2	K1	N3	4	-
76	2	L2	P4	√	D1
77	2	P3	L1	√	D2
78	2	R4	M2	6	-
79	2	R3	M1	4	-
80	2	T4	N2	4	-
81	2	N1	T3	6	VREF
82	2	P2	U5	√	-
83	2	P1	U4	4	-
84	2	R2	U3	6	-
85	2	V5	R1	√	D3

Table 23: **FG680 Differential Pin Pair Summary XCV600E, XCV1000E, XCV1600E, XCV2000E**

Pair	Bank	P Pin	N Pin	AO	Other Functions
86	2	V4	T2	√	-
87	2	V3	T1	7	-
88	2	W4	U2	4	-
89	2	W3	U1	√	VREF
90	2	AA3	V2	√	-
91	2	AA4	V1	4	VREF
92	2	AB2	W2	√	-
93	3	AB4	W1	4	VREF
94	3	AB5	Y2	√	-
95	3	AC2	Y1	√	VREF
96	3	AC3	AA1	4	-
97	3	AC4	AA2	7	-
98	3	AC5	AB1	√	-
99	3	AD3	AC1	√	VREF
100	3	AD1	AD4	6	-
101	3	AD2	AE3	4	-
102	3	AE1	AE4	√	-
103	3	AE2	AF3	6	VREF
104	3	AF4	AF1	4	-
105	3	AG3	AF2	4	-
106	3	AG4	AG1	6	-
107	3	AH3	AG2	√	D5
108	3	AH1	AJ2	√	VREF
109	3	AH2	AJ3	4	-
110	3	AJ1	AJ4	√	-
111	3	AK1	AK3	√	VREF
112	3	AK2	AK4	4	-
113	3	AL1	AL2	7	VREF
114	3	AM1	AL3	√	-
115	3	AM2	AL4	√	VREF
116	3	AM3	AN1	6	-
117	3	AM4	AP1	4	-
118	3	AN2	AP2	√	-
119	3	AN3	AR1	6	VREF

FG860 Fine-Pitch Ball Grid Array Package

XCV1000E, XCV1600E, and XCV2000E devices in the FG680 fine-pitch Ball Grid Array package have footprint compatibility. Pins labeled I0_VREF can be used as either in all parts unless device-dependent as indicated in the footnotes. If the pin is not used as V_{REF}, it can be used as general I/O. Immediately following Table 24, see Table 25 for Differential Pair information.

Table 24: **FG860 — XCV1000E, XCV1600E, XCV2000E**

Bank	Pin Description	Pin #
0	GCK3	C22
0	IO	A26
0	IO	B31
0	IO	B34
0	IO	C24
0	IO	C29
0	IO	C34
0	IO	D24
0	IO	D36
0	IO	D40
0	IO	E26
0	IO	E28
0	IO	E35
0	IO_L0N_Y	A38
0	IO_L0P_Y	D38
0	IO_L1N_Y	B37
0	IO_L1P_Y	E37
0	IO_VREF_L2N_Y	A37
0	IO_L2P_Y	C39
0	IO_L3N_Y	B36
0	IO_L3P_Y	C38
0	IO_L4N_YY	A36
0	IO_L4P_YY	B35
0	IO_VREF_L5N_YY	A35
0	IO_L5P_YY	D37
0	IO_L6N_Y	C37
0	IO_L6P_Y	A34
0	IO_L7N_Y	E36
0	IO_L7P_Y	B33
0	IO_L8N_YY	A33
0	IO_L8P_YY	C32
0	IO_VREF_L9N_YY	C36
0	IO_L9P_YY	B32
0	IO_L10N_Y	A32
0	IO_L10P_Y	D35
0	IO_VREF_L11N_Y	C31[2]
0	IO_L11P_Y	C35
0	IO_L12N_YY	E34
0	IO_L12P_YY	A31
0	IO_VREF_L13N_YY	D34
0	IO_L13P_YY	C30
0	IO_L14N_Y	B30
0	IO_L14P_Y	E33
0	IO_L15N_Y	A30
0	IO_L15P_Y	D33
0	IO_VREF_L16N_YY	C33
0	IO_L16P_YY	B29
0	IO_L17N_YY	E32
0	IO_L17P_YY	A29
0	IO_L18N_Y	D32
0	IO_L18P_Y	C28
0	IO_L19N_Y	E31
0	IO_L19P_Y	B28
0	IO_L20N_Y	D31
0	IO_L20P_Y	A28
0	IO_L21N_Y	D30
0	IO_L21P_Y	C27
0	IO_L22N_YY	E29
0	IO_L22P_YY	B27
0	IO_VREF_L23N_YY	D29
0	IO_L23P_YY	A27
0	IO_L24N_Y	C26
0	IO_L24P_Y	D28
0	IO_L25N_Y	B26
0	IO_L25P_Y	F27
0	IO_L26N_YY	E27
0	IO_L26P_YY	C25

Table 26: **FG900 — XCV600E, XCV1000E, XCV1600E**

Bank	Pin Description	Pin #
1	IO	J20[5]
1	IO	L18[4]
1	IO_LVDS_DLL_L34P	E16
1	IO_L35N_YY	B16
1	IO_VREF_L35P_YY	F16[2]
1	IO_L36N_YY	A16
1	IO_L36P_YY	H16
1	IO_L37N_YY	C16
1	IO_VREF_L37P_YY	K15
1	IO_L38N_YY	K16
1	IO_L38P_YY	G16
1	IO_L39N_Y	A17
1	IO_L39P_Y	E17
1	IO_L40N_Y	F17
1	IO_L40P_Y	C17
1	IO_L41N_YY	E18
1	IO_VREF_L41P_YY	A18
1	IO_L42N_YY	D18
1	IO_L42P_YY	A19
1	IO_L43N_Y	B19
1	IO_L43P_Y	G18
1	IO_L44N_Y	D19
1	IO_L44P_Y	H18
1	IO_L45N_YY	F18
1	IO_VREF_L45P_YY	F19[1]
1	IO_L46N_YY	B20
1	IO_L46P_YY	K17
1	IO_L47N_Y	D20[4]
1	IO_L47P_Y	A20[4]
1	IO_L48N_Y	G19
1	IO_L48P_Y	C20
1	IO_L49N_Y	K18
1	IO_L49P_Y	E20
1	IO_L50N_YY	B21[4]
1	IO_L50P_YY	D21[4]
1	IO_L51N_YY	F20
1	IO_L51P_YY	A21

Table 26: **FG900 — XCV600E, XCV1000E, XCV1600E**

Bank	Pin Description	Pin #
1	IO_L52N_YY	C21
1	IO_VREF_L52P_YY	A22
1	IO_L53N_YY	H19
1	IO_L53P_YY	B22
1	IO_L54N_YY	E21
1	IO_L54P_YY	D22
1	IO_L55N_YY	F21
1	IO_VREF_L55P_YY	C22
1	IO_L56N_YY	H20
1	IO_L56P_YY	E22
1	IO_L57N_Y	G21
1	IO_L57P_Y	A23
1	IO_L58N_Y	A24
1	IO_L58P_Y	K19
1	IO_L59N_YY	C24
1	IO_VREF_L59P_YY	B24
1	IO_L60N_YY	H21
1	IO_L60P_YY	G22
1	IO_L61N_Y	E23
1	IO_L61P_Y	C25
1	IO_L62N_Y	D24
1	IO_L62P_Y	A26
1	IO_L63N_YY	B26
1	IO_VREF_L63P_YY	K20
1	IO_L64N_YY	D25
1	IO_L64P_YY	J21
1	IO_L65N_Y	C26[4]
1	IO_L65P_Y	F23[4]
1	IO_L66N_Y	B27
1	IO_VREF_L66P_Y	G23[1]
1	IO_L67N_Y	A27
1	IO_L67P_Y	F24
1	IO_L68N_YY	B28[3]
1	IO_L68P_YY	A28[4]
1	IO_WRITE_L69N_YY	K21
1	IO_CS_L69P_YY	C27

Table 26: **FG900 — XCV600E, XCV1000E, XCV1600E**

Bank	Pin Description	Pin #
2	IO_L99P_YY	N26
2	IO_L99N_YY	P28
2	IO_L100P	P29
2	IO_L100N	N24
2	IO_L101P_YY	P22
2	IO_L101N_YY	R26
2	IO_VREF_L102P_YY	P25
2	IO_L102N_YY	R29
2	IO_L103P_YY	R21[4]
2	IO_L103N_YY	R28[3]
2	IO_VREF_L104P_YY	R25[2]
2	IO_L104N_YY	T30
2	IO_L105P_YY	P24[4]
2	IO_L105N_YY	R27[3]
2	IO_L106P	R24
3	IO	T22[4]
3	IO	T24[4]
3	IO	T26[4]
3	IO	T29[4]
3	IO	U26[5]
3	IO	V23[4]
3	IO	V25[4]
3	IO	V30[5]
3	IO	Y21[4]
3	IO	AA26[4]
3	IO	AA23[4]
3	IO	AB27[4]
3	IO	AB29[4]
3	IO	AC28[5]
3	IO	AD26[4]
3	IO	AD29[5]
3	IO	AE27[5]
3	IO_L106N	U29
3	IO_L107P_YY	R22
3	IO_VREF_L107N_YY	T27[2]
3	IO_L108P_YY	R23

Table 26: **FG900 — XCV600E, XCV1000E, XCV1600E**

Bank	Pin Description	Pin #
3	IO_L108N_YY	T28
3	IO_L109P_YY	T21
3	IO_VREF_L109N_YY	T25
3	IO_L110P_YY	U28
3	IO_L110N_YY	U30
3	IO_L111P	T23
3	IO_L111N	U27
3	IO_L112P_YY	U25
3	IO_L112N_YY	V27
3	IO_D4_L113P_YY	U24
3	IO_VREF_L113N_YY	V29
3	IO_L114P	W30
3	IO_L114N	U22
3	IO_L115P_YY	U21
3	IO_L115N_YY	W29
3	IO_L116P_YY	V26
3	IO_L116N_YY	W27
3	IO_L117P	W26
3	IO_VREF_L117N	Y29[1]
3	IO_L118P_YY	W25
3	IO_L118N_YY	Y30
3	IO_L119P_Y	V24[4]
3	IO_L119N_Y	Y28[4]
3	IO_L120P_YY	AA30
3	IO_L120N_YY	W24
3	IO_L121P	AA29
3	IO_L121N	V20
3	IO_L122P	Y27[4]
3	IO_L122N	W23[4]
3	IO_L123P_YY	Y26
3	IO_D5_L123N_YY	AB30
3	IO_D6_L124P_YY	V21
3	IO_VREF_L124N_YY	AA28
3	IO_L125P_YY	Y25
3	IO_L125N_YY	AA27
3	IO_L126P_YY	W22
3	IO_L126N_YY	Y23

Table 28: **FG1156 — XCV1000E, XCV1600E, XCV2000E, XCV2600E, XCV3200E**

Bank	Pin Description	Pin #
4	IO_L212N_YY	AP18
4	IO_L213P_Y	AF18
4	IO_L213N_Y	AP17
4	IO_VREF_L214P_Y	AJ18[1]
4	IO_L214N_Y	AL18
4	IO_LVDS_DLL_L215P	AM18
5	GCK1	AL19
5	IO	AF17[3]
5	IO	AG12[3]
5	IO	AH12
5	IO	AJ10[3]
5	IO	AJ11[3]
5	IO	AK7[3]
5	IO	AK13[3]
5	IO	AL13[3]
5	IO	AM4[3]
5	IO	AN9
5	IO	AN10[3]
5	IO	AN16
5	IO	AN17[3]
5	IO_LVDS_DLL_L215N	AL17
5	IO_L216P_Y	AH17
5	IO_VREF_L216N_Y	AM17[1]
5	IO_L217P_Y	AJ17
5	IO_L217N_Y	AG17
5	IO_L218P_YY	AP16
5	IO_VREF_L218N_YY	AL16
5	IO_L219P_YY	AJ16
5	IO_L219N_YY	AM16
5	IO_L220P	AK16[5]
5	IO_L220N	AP15[4]
5	IO_L221P_Y	AL15
5	IO_L221N_Y	AH16

Table 28: **FG1156 — XCV1000E, XCV1600E, XCV2000E, XCV2600E, XCV3200E**

Bank	Pin Description	Pin #
5	IO_L222P_Y	AN15
5	IO_L222N_Y	AF16
5	IO_L223P_Y	AP14[5]
5	IO_L223N_Y	AE16[4]
5	IO_L224P_YY	AK15
5	IO_VREF_L224N_YY	AJ15
5	IO_L225P_YY	AH15
5	IO_L225N_YY	AN14
5	IO_L226P	AK14[5]
5	IO_L226N	AG15[4]
5	IO_L227P_Y	AM13
5	IO_L227N_Y	AF15
5	IO_L228P_Y	AG14
5	IO_L228N_Y	AP13
5	IO_L229P_YY	AE14[5]
5	IO_L229N_YY	AE15[4]
5	IO_L230P_YY	AN13
5	IO_VREF_L230N_YY	AG13
5	IO_L231P_YY	AH14
5	IO_L231N_YY	AP12
5	IO_L232P_Y	AJ14
5	IO_L232N_Y	AL14
5	IO_L233P_Y	AF13
5	IO_L233N_Y	AN12
5	IO_L234P_Y	AF14
5	IO_L234N_Y	AP11
5	IO_L235P_Y	AN11
5	IO_L235N_Y	AH13
5	IO_L236P_YY	AM12
5	IO_L236N_YY	AL12
5	IO_L237P_YY	AJ13
5	IO_VREF_L237N_YY	AP10
5	IO_L238P_Y	AK12
5	IO_L238N_Y	AM10

Table 28: **FG1156 — XCV1000E, XCV1600E, XCV2000E, XCV2600E, XCV3200E**

Bank	Pin Description	Pin #
NA	GND	R15
NA	GND	P15
NA	GND	L3
NA	GND	G7
NA	GND	E30
NA	GND	C24
NA	GND	B34
NA	GND	AP32
NA	GND	AM1
NA	GND	AM34
NA	GND	AJ29
NA	GND	AF9
NA	GND	AA17
NA	GND	Y17
NA	GND	W16
NA	GND	V16
NA	GND	U17
NA	GND	T17
NA	GND	R16
NA	GND	P16
NA	GND	L32
NA	GND	G28
NA	GND	D4
NA	GND	C32
NA	GND	A1
NA	GND	AP33
NA	GND	AM2
NA	GND	AL4
NA	GND	AH1
NA	GND	AF26
NA	GND	AA18
NA	GND	Y18
NA	GND	W17
NA	GND	V17
NA	GND	U18
NA	GND	T18
NA	GND	R17
NA	GND	P17
NA	GND	J9
NA	GND	G34
NA	GND	D31
NA	GND	C33
NA	GND	A2
NA	GND	AB17
NA	GND	AB18
NA	GND	N17
NA	GND	N18
NA	GND	U13
NA	GND	V13
NA	GND	U22
NA	GND	V22

Notes:

1. V_{REF} or I/O option only in the XCV1600E, XCV2000E, XCV2600E, and XCV3200E; otherwise, I/O option only.
2. V_{REF} or I/O option only in the XCV2000E, XCV2600E, and XCV3200E; otherwise, I/O option only.
3. No Connect in the XCV1000E, XCV1600E.
4. No Connect in the XCV1000E.
5. I/O in the XCV1000E.

Table 29: **FG1156 Differential Pin Pair Summary: XCV1000E, XCV1600E, XCV2000E, XCV2600E, XCV3200E**

Pair	Bank	P Pin	N Pin	AO	Other Functions
153	3	AD31	AF33	3200 2600 2000 1600 1000	VREF
154	3	AC28	AF31	3200 2600 1600 1000	-
155	3	AC27	AF32	3200 2600 1600	-
156	3	AE29	AD28	2600 1000	VREF
157	3	AD30	AG32	3200 2600 2000 1600 1000	-
158	3	AC26	AH33	2000 1600	-
159	3	AD26	AF30	3200 2600 2000 1600 1000	VREF
160	3	AC25	AH32	2600 2000 1000	-
161	3	AE28	AL34	3200 2600 2000	-
162	3	AG30	AD27	3200 2600 1600 1000	-
163	3	AF29	AK34	3200 2600 2000 1600 1000	-
164	3	AD25	AE27	3200 2600 2000 1600	-
165	3	AJ33	AH31	2600 2000 1000	VREF
166	3	AE26	AL33	3200 2600 1600 1000	-
167	3	AF28	AL32	2600 1600	-
168	3	AJ31	AF27	3200 2600 1600 1000	VREF
169	3	AG29	AJ32	2600 2000 1000	-
170	3	AK33	AH30	3200 2600 2000	-
171	3	AK32	AK31	3200 2600 2000 1600 1000	INIT

Table 29: **FG1156 Differential Pin Pair Summary: XCV1000E, XCV1600E, XCV2000E, XCV2600E, XCV3200E**

Pair	Bank	P Pin	N Pin	AO	Other Functions
172	4	AP31	AK29	3200 2600 2000 1600 1000	-
173	4	AP30	AN31	3200 1600 1000	-
174	4	AH27	AN30	3200 2000 1000	-
175	4	AM30	AK28	3200 2000 1000	VREF
176	4	AG26	AN29	3200 2600 1000	-
177	4	AF25	AM29	3200 2600 2000 1600 1000	-
178	4	AL29	AL28	3200 2600 2000 1600 1000	VREF
179	4	AE24	AN28	2000 1600	-
180	4	AJ27	AH26	3200 1000	-
181	4	AG25	AK27	3200 1000	-
182	4	AM28	AF24	3200 2600	-
183	4	AJ26	AP27	3200 2600 2000 1600 1000	-
184	4	AK26	AN27	3200 2600 2000 1600 1000	VREF
185	4	AE23	AM27	3200 1600	-
186	4	AL26	AP26	3200 2000 1000	-
187	4	AN26	AJ25	3200 2000 1000	VREF
188	4	AG24	AP25	3200 2600	-
189	4	AF23	AM26	3200 2600 2000 1600 1000	-
190	4	AJ24	AN25	3200 2600 2000 1600 1000	VREF
191	4	AE22	AM25	2600 1600 1000	-